

FX605

P-Channel Silicon MOSFET

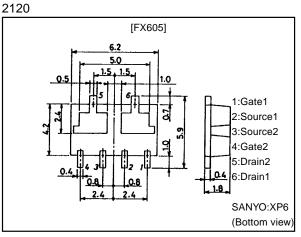
# **Ultrahigh-Speed Switching Applications**

#### **Features**

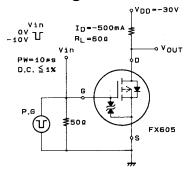
- Composite type composed of two low ON-resistance P-channel MOSFET chips for ultrahigh-speed switching and low-voltage drive.
- · Facilitates high-density mounting.
- $\cdot$  The FX605 is formed with two chips, each being
- equivalent to the 2SJ190, placed in one package.
- · Matched pair characteristics.

# **Package Dimensions**

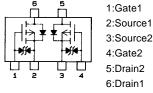
unit:mm



## Switching Time Test Clrcuit



# **Electrical Connection**



(Top view)

# **Specifications**

#### Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		-60	V
Gate-to-Source Voltage	VGSS		±15	V
Drain Current (DC)	ID		-1	A
Drain Current (Pulse)	I <sub>DP</sub>	PW≤10µs, duty cycle≤1%	-4	A
Allowable Power Dissipation	PD	Tc=25°C, 1unit	6	W
	PD	Mounted on ceramic board (750mm <sup>2</sup> ×0.8mm) 1unit	1.5	W
Total Dissipation	PT	Mounted on ceramic board (750mm <sup>2</sup> ×0.8mm)	2	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

· Marking:605

Continued on next page.

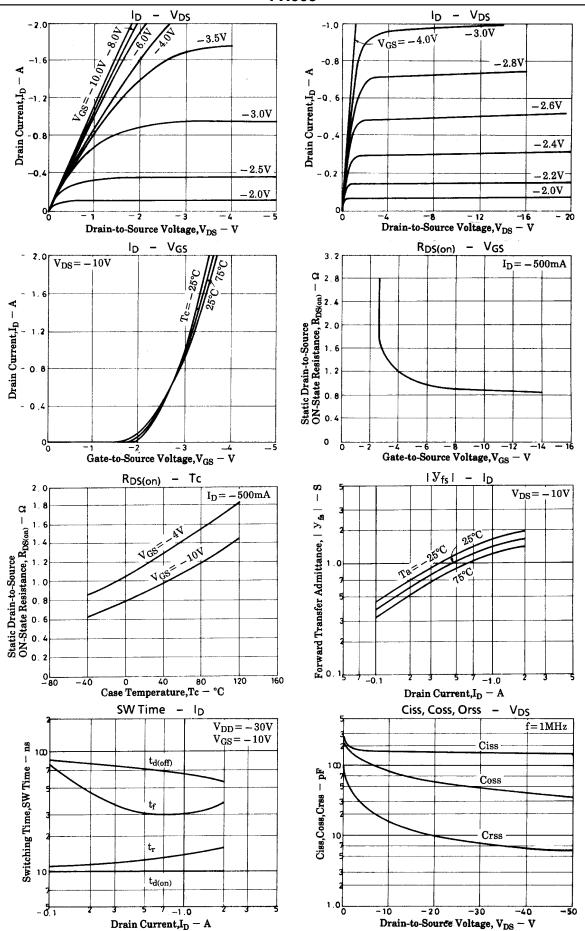


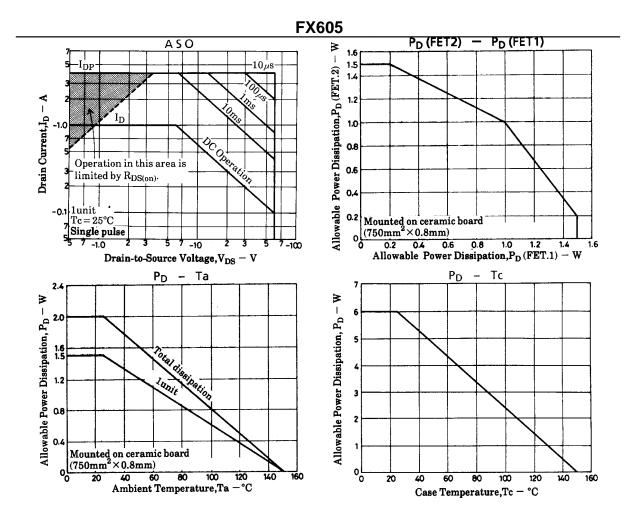
52098HA (KT)/71095MO(KOTO) TA-0111 No.4888-1/4

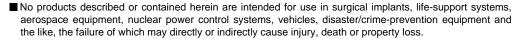
## Continued from preceding page.

#### **Electrical Characteristics at Ta = 25°C**

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
D-S Breakdown Voltage	V(BR)DSS	I <sub>D</sub> =-1mA, V <sub>GS</sub> =0	-60			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =-60V, V <sub>GS</sub> =0			-100	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±12, V <sub>DS</sub> =0			±10	μA
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =-10V, I <sub>D</sub> =-1mA	-1.0		-2.0	V
Forward Transfer Admittance	Y <sub>fs</sub>	V <sub>DS</sub> =-10V, I <sub>D</sub> =-500mA	0.6	1.0		S
Static Drain-to-Source ON-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =-500mA, V <sub>GS</sub> =-10V		0.9	1.2	Ω
	R <sub>DS(on)</sub>	I <sub>D</sub> =-500mA, V <sub>GS</sub> =-4V		1.2	1.6	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =-20V, f=1MHz		160		pF
Output Capacitance	Coss	V <sub>DS</sub> =-20V, f=1MHz		60		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =-20V, f=1MHz		10		pF
Turn-ON Delay Time	<sup>t</sup> d(on)	See Specified Test Circuit		10		ns
Rise Time	tr	See Specified Test Circuit		13		ns
Turn-OFF Delay Time	td(off)	See Specified Test Circuit		70		ns
Fall Time	t <sub>f</sub>	See Specified Test Circuit		30		ns
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1A, V <sub>GS</sub> =0		-0.9		V







- Anyone purchasing any products described or contained herein for an above-mentioned use shall:

  Accept full responsibility and indemnify and defend SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors and all their officers and employees, jointly and severally, against any and all claims and litigation and all damages, cost and expenses associated with such use:
  - ② Not impose any responsibility for any fault or negligence which may be cited in any such claim or litigation on SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors or any of their officers and employees jointly or severally.

Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. SANYO believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

This catalog provides information as of May, 1998. Specifications and information herein are subject to change without notice.